Min track width – 8mils (200 microns)
Min space track/pad – 6mils (200 microns)
Min space track/track – 6mils (250 microns)
Max panel size – 480 x 580 mm
Min thickness of the board – 0,1mm
Max thickness of the board – 3,2mm
Min hole – 0,3mm
Max layers – 8
Max aspect ratio – 4:1
Soldermask – liquid, photosensible
Soldermask colour – dark-green (standard), grass-green, blue, red, black, white
Copper thickness inside hole –> 25 microns